

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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LTCC Multi Layer Ceramic Band Pass Filter- 1608 (0603) size

- RFBPF1608060K98Q1C Low Profile Design
- For 5 GHz ISM Band Application

FEATURES

- Miniature footprint: 1.6X 0.8 X 0.6 mm³
- Low Insertion loss
- High attenuation on harmonic suppressed
- LTCC process

APPLICATIONS

■ 5150 - 5950 MHz band RF applications.

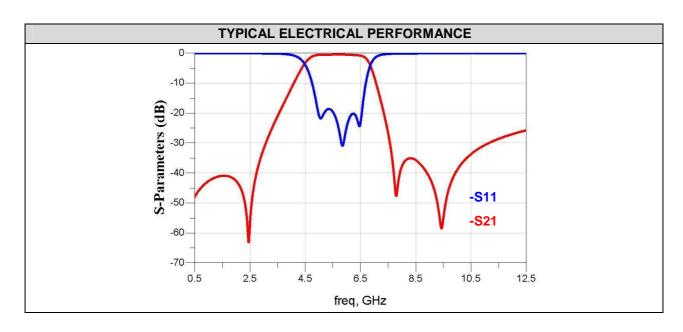
ELECTRICAL CHARACTERISTICS

5150 - 5950 MHz
0100 0000 III IE
0.6 dB Max.
40.0 dB min. @ 30 - 2700 MHz 12.0 dB min. @ 7250 - 7800 MHz 20.0 dB min. @ 10300 - 11700 MHz
2.0 max.
50 Ω
-40°C - +85°C
40 12 20 2.0

Taping Quantity : 4000pcs per 7" reel

Operating Temperature Range : $-40 - +85^{\circ}$ C Storage Temperature Range : $-10 - +40^{\circ}$ C

Humidity :30 to 70% relative humidity
Moisture sensitivity levels : MSL is LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)





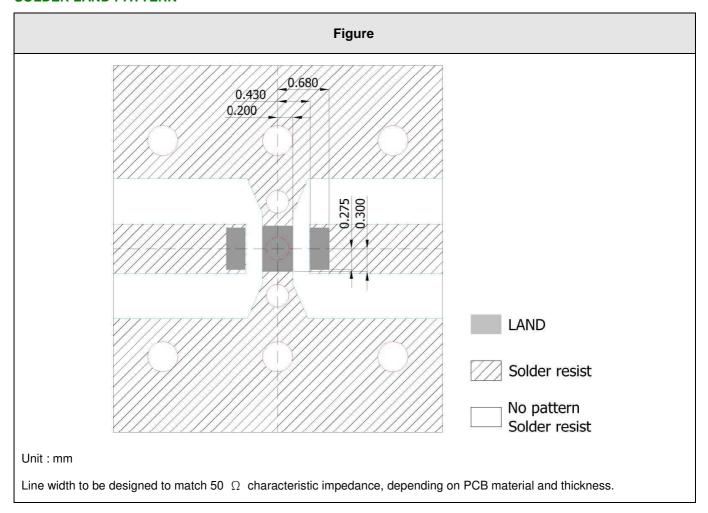
CONSTRUCTION

Figure				PIN	Connection	
Top view	P1	P2	P3		1	Input Port
					2	GND
					3	output Port

DIMENSIONS

Figure	Symbol	Dimension (mm)
Top view	L	1.60 ± 0.10
L L	W	0.80 ± 0.10
A	Т	0.60 max.
w	А	0.55 ± 0.10
Side view	В	0.60 ± 0.10
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	С	0.25 ± 0.10
A A G	D	0.23 ± 0.10
B A	E	0.40 ± 0.10
Bottom view	F	0.12 ± 0.10
	G	0.125 ± 0.10

SOLDER LAND PATTERN



CONTACT INFORMATION

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